## FEATURES



## GENERAL DESCRIPTION

The AD9430 is a 12 -bit, monolithic, sampling analog-to-digital converter (ADC) optimized for high performance, low power, and ease of use. The product operates up to a 210 MSPS conversion rate and is optimized for outstanding dynamic performance in wideband carrier and broadband systems. All necessary functions, including a track-and-hold (T/H) and reference, are included on the chip to provide a complete conversion solution.

The ADC requires a 3.3 V power supply and a differential ENCODE clock for full performance operation. The digital outputs are TTL/CMOS or LVDS compatible and support either twos complement or offset binary format. Separate output power supply pins support interfacing with 3.3 V or 2.5 V CMOS logic.
Two output buses support demultiplexed data up to 105 MSPS rates in CMOS mode. A data sync input is supported for proper output data port alignment in CMOS mode, and a data clock output is available for proper output data timing. In LVDS mode, the chip provides data at the ENCODE clock rate.
Fabricated on an advanced BiCMOS process, the AD9430 is available in a 100 -lead, surface-mount plastic package ( 100 e-PAD TQFP) specified over the industrial temperature range $\left(-40^{\circ} \mathrm{C}\right.$ to $\left.+85^{\circ} \mathrm{C}\right)$.

## Rev. D

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## FUNCTIONAL BLOCK DIAGRAM



Figure 1.

## APPLICATIONS

Wireless and wired broadband communications
Cable reverse path
Communications test equipment
Radar and satellite subsystems
Power amplifier linearization

## PRODUCT HIGHLIGHTS

1. High performance.

Maintains 65 dB SNR @ 210 MSPS with a 65 MHz input.
2. Low power.

Consumes only 1.3 W @ 210 MSPS.
3. Ease of use.

LVDS output data and output clock signal allow interface to current FPGA technology. The on-chip reference and sample-and-hold provide flexibility in system design. Use of a single 3.3 V supply simplifies system power supply design.
4. Out of range (OR) feature.

The OR output bit indicates when the input signal is beyond the selected input range.
5. Pin compatible with 10 -bit AD9411 (LVDS only).

## AD9430

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## AD9430

## DC SPECIFICATIONS

$\mathrm{AVDD}=3.3 \mathrm{~V}, \mathrm{DRVDD}=3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{MIN}}=-40^{\circ} \mathrm{C}, \mathrm{T}_{\mathrm{MAX}}=+85^{\circ} \mathrm{C}, \mathrm{f}_{\mathrm{IN}}=-0.5 \mathrm{dBFS}$, internal reference, full scale $=1.536 \mathrm{~V}, \mathrm{LVDS}$ output mode, unless otherwise noted.

Table 1.


| Parameter | Temp | Test Level | AD9430-170 |  |  | AD9430-210 |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Typ | Max | Min | Typ | Max |  |
| POWER SUPPLY (CMOS Mode) |  |  |  |  |  |  |  |  |  |
| AVDD | Full | IV | 3.1 | 3.3 | 3.6 | 3.2 | 3.3 | 3.6 | V |
| DRVDD | Full | IV | 3.0 | 3.3 | 3.6 | 3.0 | 3.3 | 3.6 | V |
| Supply Currents |  |  |  |  |  |  |  |  |  |
| $\mathrm{I}_{\text {Avdo }}(\mathrm{AVDD}=3.3 \mathrm{~V})^{5}$ | Full | IV |  | 335 | 372 |  | 390 | 450 | mA |
| $\mathrm{I}_{\text {DRVDD }}(\text { DRVDD }=3.3 \mathrm{~V})^{5}$ | Full | IV |  | 24 | 30 |  | 30 | 30 | mA |
| Power Dissipation ${ }^{5}$ | Full | IV |  | 1.1 |  |  | 1.3 |  |  |
| Power Supply Rejection | $25^{\circ} \mathrm{C}$ | V |  | -7.5 |  |  | -7.5 |  | $\mathrm{mV} / \mathrm{V}$ |

${ }^{1}$ Internal reference mode; SENSE = Floats.
${ }^{2}$ External reference mode; SENSE = DRVDD, VREF driven by external 1.23 V reference.
${ }^{3}$ S5 (Pin 1) = GND. See the Analog Input section. $\mathrm{S} 5=\mathrm{GND}$ in all dc and ac tests, unless otherwise noted.
${ }^{4} \mathrm{I}_{\text {AVDD }}$ and $\mathrm{I}_{\text {DRVDD }}$ are measured with an analog input of $10.3 \mathrm{MHz},-0.5 \mathrm{dBFS}$, sine wave, rated ENCODE rate, and in LVDS output mode. See Typical Performance Characteristics and Application Notes sections for IDRVDD. Power consumption is measured with a dc input at rated ENCODE rate in LVDS output mode.
${ }^{5} I_{\text {AVDD }}$ and $I_{\text {DRVDD }}$ are measured with an analog input of $10.3 \mathrm{MHz},-0.5 \mathrm{dBFS}$, sine wave, rated ENCODE rate, and in CMOS output mode. See Typical Performance Characteristics and Application Notes sections for I IRvid. Power consumption is measured with a dc input at rated ENCODE rate in CMOS output mode.

## AD9430

## AC SPECIFICATIONS

$\mathrm{AVDD}=3.3 \mathrm{~V}, \mathrm{DRVDD}=3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{MIN}}=-40^{\circ} \mathrm{C}, \mathrm{T}_{\mathrm{MAX}}=+85^{\circ} \mathrm{C}, \mathrm{f}_{\mathrm{IN}}=-0.5 \mathrm{dBFS}$, internal reference, full scale $=1.536 \mathrm{~V}$, LVDS output mode, unless otherwise noted. ${ }^{1}$

Table 2.

| Parameter |  | Temp | Test Level | AD9430-170 |  |  | AD9430-210 |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Typ | Max | Min | Typ | Max |  |
| SNR <br> Analog Input @ - 0.5 dBFS | $\begin{aligned} & 10 \mathrm{MHz} \\ & 70 \mathrm{MHz} \\ & 100 \mathrm{MHz} \\ & 240 \mathrm{MHz} \end{aligned}$ | $\begin{aligned} & 25^{\circ} \mathrm{C} \\ & 25^{\circ} \mathrm{C} \\ & 25^{\circ} \mathrm{C} \\ & 25^{\circ} \mathrm{C} \end{aligned}$ | $\begin{aligned} & \mathrm{I} \\ & \mathrm{I} \\ & \mathrm{~V} \\ & \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 63.5 \\ & 63 \end{aligned}$ | $\begin{aligned} & 65 \\ & 65 \\ & 65 \\ & 61 \end{aligned}$ |  | $\begin{aligned} & 62.5 \\ & 62.5 \end{aligned}$ | $\begin{aligned} & 64.5 \\ & 64.5 \\ & 64.5 \\ & 61 \end{aligned}$ |  | dB <br> dB <br> dB <br> dB |
| SINAD <br> Analog Input @ -0.5 dBFS | $\begin{aligned} & 10 \mathrm{MHz} \\ & 70 \mathrm{MHz} \\ & 100 \mathrm{MHz} \\ & 240 \mathrm{MHz} \end{aligned}$ | $\begin{aligned} & 25^{\circ} \mathrm{C} \\ & 25^{\circ} \mathrm{C} \\ & 25^{\circ} \mathrm{C} \\ & 25^{\circ} \mathrm{C} \end{aligned}$ | $\begin{aligned} & \mathrm{I} \\ & \mathrm{I} \\ & \mathrm{~V} \\ & \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 63.5 \\ & 63 \end{aligned}$ | $\begin{aligned} & 65 \\ & 65 \\ & 65 \\ & 60 \end{aligned}$ |  | $\begin{aligned} & 62.5 \\ & 62.5 \end{aligned}$ | $\begin{aligned} & 64.5 \\ & 64.5 \\ & 64.5 \\ & 60 \end{aligned}$ |  | dB <br> dB <br> dB <br> dB |
| EFFECTIVE NUMBER OF BITS (ENOB) | $\begin{aligned} & 10 \mathrm{MHz} \\ & 70 \mathrm{MHz} \\ & 100 \mathrm{MHz} \\ & 240 \mathrm{MHz} \end{aligned}$ | $\begin{aligned} & 25^{\circ} \mathrm{C} \\ & 25^{\circ} \mathrm{C} \\ & 25^{\circ} \mathrm{C} \\ & 25^{\circ} \mathrm{C} \end{aligned}$ | $\begin{aligned} & \mathrm{I} \\ & \text { I } \\ & \mathrm{V} \\ & \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 10.3 \\ & 10.3 \end{aligned}$ | $\begin{aligned} & 10.6 \\ & 10.6 \\ & 10.6 \\ & 9.8 \end{aligned}$ |  | $\begin{aligned} & 10.2 \\ & 10.2 \end{aligned}$ | $\begin{aligned} & 10.5 \\ & 10.5 \\ & 10.5 \\ & 9.8 \end{aligned}$ |  | Bits <br> Bits <br> Bits <br> Bits |
| WORST HARMONIC (2nd or 3rd) <br> Analog Input @ -0.5 dBFS, 10 MHz | $\begin{aligned} & 10 \mathrm{MHz} \\ & 70 \mathrm{MHz} \\ & 100 \mathrm{MHz} \\ & 240 \mathrm{MHz} \end{aligned}$ | $\begin{aligned} & 25^{\circ} \mathrm{C} \\ & 25^{\circ} \mathrm{C} \\ & 25^{\circ} \mathrm{C} \\ & 25^{\circ} \mathrm{C} \end{aligned}$ | $\begin{aligned} & \mathrm{I} \\ & \text { I } \\ & \mathrm{V} \\ & \mathrm{~V} \end{aligned}$ |  | $\begin{aligned} & -85 \\ & -85 \\ & -77 \\ & -63 \end{aligned}$ | $\begin{aligned} & -75 \\ & -75 \end{aligned}$ |  | $\begin{aligned} & -84 \\ & -84 \\ & -77 \\ & -63 \end{aligned}$ | $\begin{aligned} & -74 \\ & -74 \end{aligned}$ | dBc <br> dBc <br> dBc <br> dBc |
| WORST HARMONIC (4th or Higher) <br> Analog Input @ -0.5 dBFS, 10 MHz | $\begin{aligned} & 10 \mathrm{MHz} \\ & 70 \mathrm{MHz} \\ & 100 \mathrm{MHz} \\ & 240 \mathrm{MHz} \end{aligned}$ | $\begin{aligned} & 25^{\circ} \mathrm{C} \\ & 25^{\circ} \mathrm{C} \\ & 25^{\circ} \mathrm{C} \\ & 25^{\circ} \mathrm{C} \end{aligned}$ | $\begin{aligned} & \text { I } \\ & \text { I } \\ & \text { V } \\ & \text { V } \end{aligned}$ |  | $\begin{aligned} & -87 \\ & -87 \\ & -77 \\ & -63 \end{aligned}$ | $\begin{aligned} & -78 \\ & -78 \end{aligned}$ |  | $\begin{aligned} & -87 \\ & -87 \\ & -77 \\ & -63 \end{aligned}$ | $\begin{aligned} & -77 \\ & -77 \end{aligned}$ | dBc <br> dBc <br> dBc <br> dBc |
| TWO-TONE IMD ${ }^{2}$ <br> F1, F2 @ -7 dBFS |  | $25^{\circ} \mathrm{C}$ | V |  | -75 |  |  | -75 |  | dBc |
| ANALOG INPUT BANDWIDTH |  | $25^{\circ} \mathrm{C}$ | V |  | 700 |  |  | 700 |  | MHz |

${ }^{1}$ All ac specifications tested by differentially driving CLK+ and CLK-.
${ }^{2} \mathrm{~F} 1=28.3 \mathrm{MHz}$, F2 $=29.3 \mathrm{MHz}$.

## DIGITAL SPECIFICATIONS

AVDD $=3.3 \mathrm{~V}, \mathrm{DRVDD}=3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{MIN}}=-40^{\circ} \mathrm{C}, \mathrm{T}_{\mathrm{MAX}}=+85^{\circ} \mathrm{C}$, unless otherwise noted.
Table 3.

|  | Temp | Test Level | AD9430-170 |  |  | AD9430-210 |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Parameter |  |  | Min | Typ | Max | Min | Typ | Max |  |
| ENCODE AND DS INPUTS (CLK+, CLK-, DS+, DS-) ${ }^{1}$ <br> Differential Input Voltage ${ }^{2}$ Common-Mode Voltage ${ }^{3}$ Input Resistance Input Capacitance | Full <br> Full <br> Full <br> $25^{\circ} \mathrm{C}$ | $\begin{aligned} & \mathrm{IV} \\ & \mathrm{VI} \\ & \mathrm{VI} \\ & \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 0.2 \\ & 1.375 \\ & 3.2 \end{aligned}$ | $\begin{aligned} & 1.5 \\ & 5.5 \\ & 4 \end{aligned}$ | $\begin{aligned} & 1.575 \\ & 6.5 \end{aligned}$ | $\begin{aligned} & 0.2 \\ & 1.375 \\ & 3.2 \end{aligned}$ | $\begin{aligned} & 1.5 \\ & 5.5 \\ & 4 \end{aligned}$ | $\begin{aligned} & 1.575 \\ & 6.5 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{k} \Omega \\ & \mathrm{pF} \end{aligned}$ |
| LOGIC INPUTS (S1, S2, S4, S5) <br> Logic 1 Voltage Logic 0 Voltage Logic 1 Input Current Logic 0 Input Current Input Resistance Input Capacitance | Full <br> Full <br> Full <br> Full <br> $25^{\circ} \mathrm{C}$ <br> $25^{\circ} \mathrm{C}$ | $\begin{aligned} & \mathrm{IV} \\ & \mathrm{IV} \\ & \mathrm{VI} \\ & \mathrm{VI} \\ & \mathrm{~V} \\ & \mathrm{~V} \end{aligned}$ | 2.0 | $\begin{aligned} & 30 \\ & 4 \end{aligned}$ | $\begin{aligned} & 0.8 \\ & 190 \\ & 10 \end{aligned}$ | 2.0 | $\begin{array}{\|l} \hline 30 \\ 4 \end{array}$ | $\begin{aligned} & 0.8 \\ & 190 \\ & 10 \end{aligned}$ | V <br> V <br> $\mu \mathrm{A}$ <br> $\mu \mathrm{A}$ <br> k $\Omega$ <br> pF |
| LOGIC OUTPUTS (CMOS Mode) <br> Logic 1 Voltage ${ }^{4}$ <br> Logic 0 Voltage ${ }^{4}$ | Full <br> Full | IV <br> IV | $\begin{aligned} & \text { DRVDD } \\ & -0.05 \end{aligned}$ |  | 0.05 | $\begin{aligned} & \text { DRVDD } \\ & -0.05 \end{aligned}$ |  | 0.05 |  |
| LOGIC OUTPUTS (LVDS Mode) ${ }^{4,5}$ <br> Vod Differential Output Voltage <br> Vos Output Offset Voltage <br> Output Coding | $\begin{aligned} & \text { Full } \\ & \text { Full } \end{aligned}$ | $\begin{aligned} & \mathrm{VI} \\ & \mathrm{VI} \end{aligned}$ | 247 <br> 1.125 <br> Twos co | leme | 454 <br> 1.375 <br> inary | 247 <br> 1.125 <br> Twos co | leme | 454 <br> 1.375 <br> nary | $\begin{aligned} & \mathrm{mV} \\ & \mathrm{~V} \end{aligned}$ |

${ }^{1}$ ENCODE (Clock) and DS inputs identical on the chip. See the Equivalent Circuits section.
${ }^{2}$ All ac specifications tested by driving CLK + and CLK- differentially, |(CLK+) - (CLK-)| $>200 \mathrm{mV}$.
${ }^{3}$ ENCODE (Clock) inputs' common-mode can be externally set, such that $0.9 \mathrm{~V}<(C L K+$ or CLK-) $<2.6 \mathrm{~V}$.
${ }^{4}$ Digital output logic levels: DRVDD $=3.3 \mathrm{~V}, \mathrm{C}_{\mathrm{LOAD}}=5 \mathrm{pF}$.
${ }^{5}$ LVDS R ${ }_{\text {TERM }}=100 \Omega$, LVDS output current set resistor $\left(R_{\text {SET }}\right)=3.74 \mathrm{k} \Omega$ ( $1 \%$ tolerance).

## AD9430

## SWITCHING SPECIFICATIONS

$\mathrm{AVDD}=3.3 \mathrm{~V}, \mathrm{DRVDD}=3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{MIN}}=-40^{\circ} \mathrm{C}, \mathrm{T}_{\mathrm{MAX}}=+85^{\circ} \mathrm{C}$, unless otherwise noted.
Table 4.

| Parameter (Conditions) | Temp | Test Level | AD9430-170 |  |  | AD9430-210 |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Typ | Max | Min | Typ | Max |  |
| Maximum Conversion Rate ${ }^{1}$ | Full | VI | 170 |  |  | 210 |  |  | MSPS |
| Minimum Conversion Rate ${ }^{1}$ | Full | V |  |  | 40 |  |  | 40 | MSPS |
| CLK+ Pulse Width High (ter) ${ }^{1}$ | Full | IV | 2 |  | 12.5 | 2 |  | 12.5 | ns |
| CLK+ Pulse Width Low ( $\left.\mathrm{teL}^{\text {L }}\right)^{1}$ | Full | IV | 2 |  | 12.5 | 2 |  | 12.5 | ns |
| DS Input Setup Time (tsos) ${ }^{2}$ | Full | IV | -0.5 |  |  | -0.5 |  |  | ns |
| DS Input Hold Time (thos) ${ }^{2}$ | Full | IV | 1.75 |  |  | 1.75 |  |  | ns |
| OUTPUT (CMOS Mode) |  |  |  |  |  |  |  |  |  |
| Valid Time (tv) | Full | IV | 2 |  |  | 2 |  |  | ns |
| Propagation Delay (tpd) | Full | IV |  | 3.8 | 5 |  | 3.8 | 5 | ns |
| Rise Time ( $\mathrm{t}_{\mathrm{R}}$ ) (20\% to 80\%) | $25^{\circ} \mathrm{C}$ | V |  | 1 |  |  | 1 |  | ns |
| Fall Time ( $\mathrm{t}_{\mathrm{F}}$ ) (20\% to 80\%) | $25^{\circ} \mathrm{C}$ | V |  | 1 |  |  | 1 |  | ns |
| DCO Propagation Delay (tcpD) | Full | IV |  | 3.8 | 5 |  | 3.8 | 5 | ns |
| Data to DCO Skew (tpD to $\mathrm{t}_{\text {cPD }}$ ) | Full | IV | -0.5 | 0 | +0.5 | -0.5 | 0 | +0.5 | ns |
| Interleaved Mode (A, B Latency) | Full | IV |  | 14, 14 |  |  | 14, 14 |  | Cycles |
| Parallel Mode (A, B Latency) | Full | IV |  | 15,14 |  |  | 15,14 |  | Cycles |
| OUTPUT (LVDS Mode) |  |  |  |  |  |  |  |  |  |
| Valid Time (tv) | Full | VI | 2.0 |  |  | 2.0 |  |  | ns |
| Propagation Delay (tpo) | Full | VI |  | 3.2 | 4.3 |  | 3.2 | 4.3 | ns |
| Rise Time ( $\mathrm{t}_{\mathrm{R}}$ ) (20\% to 80\%) | $25^{\circ} \mathrm{C}$ | V |  | 0.5 |  |  | 0.5 |  | ns |
| Fall Time ( $\mathrm{t}_{\mathrm{F}}$ ) (20\% to 80\%) | $25^{\circ} \mathrm{C}$ | V |  | 0.5 |  |  | 0.5 |  | ns |
| DCO Propagation Delay (tcpo | Full | VI | 1.8 | 2.7 | 3.8 | 1.8 | 2.7 | 3.8 | ns |
| Data to DCO Skew (tpd - tcpo) | Full | IV | 0.2 | 0.5 | 0.8 | 0.2 | 0.5 | 0.8 | ns |
| Latency | Full | IV |  | 14 |  |  | 14 |  | Cycles |
| APERTURE DELAY ( $\mathrm{t}_{\mathrm{A}}$ ) | $25^{\circ} \mathrm{C}$ | V |  | 1.2 |  |  | 1.2 |  | ns |
| APERTURE UNCERTAINTY (Jitter, t ) | $25^{\circ} \mathrm{C}$ | V |  | 0.25 |  |  | 0.25 |  | ps rms |
| OUT OF RANGE RECOVERY TIME (CMOS and LVDS) | $25^{\circ} \mathrm{C}$ | V |  |  | 1 |  |  | 1 | Cycles |

[^0]
## TIMING DIAGRAMS



Figure 2. CMOS Timing Diagram


Figure 3. LVDS Timing Diagram

ABSOLUTE MAXIMUM RATINGS
Table 5.

| Parameter | Rating |
| :--- | :--- |
| AVDD, DRVDD | 4 V |
| Analog Inputs | -0.5 V to AVDD +0.5 V |
| Digital Inputs | -0.5 V to DRVDD +0.5 V |
| REFIN Inputs | -0.5 V to AVDD +0.5 V |
| Digital Output Current | 20 mA |
| Operating Temperature | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Storage Temperature | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Maximum Junction Temperature | $150^{\circ} \mathrm{C}$ |
| Maximum Case Temperature | $150^{\circ} \mathrm{C}$ |
| $\theta_{\mathrm{JA}}{ }^{1}$ | $25^{\circ} \mathrm{C} / \mathrm{W}, 32^{\circ} \mathrm{C} / \mathrm{W}$ |

${ }^{1}$ Typical $\theta_{\mathrm{JA}}=32^{\circ} \mathrm{C} / \mathrm{W}$ (heat slug not soldered); typical $\theta_{\mathrm{JA}}=25^{\circ} \mathrm{C} / \mathrm{W}$ (heat slug soldered) for multilayer board in still air with solid ground plane.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those listed in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## EXPLANATION OF TEST LEVELS

Table 6.

| Level | Description |
| :--- | :--- |
| I | $100 \%$ production tested. <br> II <br> III <br> specified temproduction tested at $25^{\circ} \mathrm{C}$ and sample tested at <br> IV |
| Sample tested only. <br> Varameter is guaranteed by design and <br> characterization testing. |  |
| V | Parameter is a typical value only. <br> $100 \%$ production tested at $25^{\circ} \mathrm{C} ;$ guaranteed by <br> design and characterization testing for industrial <br> temperature range; $100 \%$ production tested at <br> temperature extremes for military devices. |

## ESD CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although this product features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


## PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS



Table 7. CMOS Mode Pin Function Descriptions

| Pin Number | Mnemonic | Description |
| :---: | :---: | :---: |
| 1 | S5 | Full-Scale Adjust Pin. AVDD sets $\mathrm{f}_{\mathrm{s}}=0.768 \mathrm{~V} \mathrm{p}-\mathrm{p}$ differential, GND sets $\mathrm{f}_{\mathrm{s}}=1.536 \mathrm{~V}$ p-p differential. |
| 2, 7, 42, 43, 65, 66, 68 | DNC | Do Not Connect. |
| 3 | S4 | Interleaved, Parallel Select Pin. High = interleaved. |
| $\begin{aligned} & 4,9,12,13,16,17,20,23,25,26,30,31,35,38,41,86 \\ & 87,91,92,93,96,97,100 \end{aligned}$ | AGND ${ }^{1}$ | Analog Ground. |
| 5 | S2 | Output Mode Select. Low = dual-port CMOS, high = LVDS. |
| 6 | S1 | Data Format Select. Low = binary, high = twos complement for both CMOS and LVDS modes. |
| $\begin{aligned} & 8,14,15,18,19,24,27,28,29,34,39,40,88,89,90,94, \\ & 95,98,99 \end{aligned}$ | AVDD | 3.3V Analog Supply. |
| 10 | SENSE | Reference Mode Select Pin. Float for internal reference operation. |
| 11 | VREF | 1.235 V Reference I/O—Function Dependent on SENSE. |
| 21 | VIN+ | Analog Input-True. |
| 22 | VIN- | Analog Input-Complement. |
| 32 | DS+ | Data Sync (Input)-True. Tie low if not used. |
| 33 | DS-2 | Data Sync (Input)-Complement. Tie high if not used. |
| 36 | CLK+ | Clock Input-True. |
| 37 | CLK- | Clock Input-Complement. |
| 44 | DB0 | B Port Output Data Bit (LSB). |
| 45 | DB1 | B Port Output Data Bit. |

## AD9430

| Pin Number | Mnemonic | Description |
| :--- | :--- | :--- |
| 46 | DB2 | B Port Output Data Bit. |
| $47,54,62,75,83$ | DRVDD | 3.3 V Digital Output Supply (3.0 V to 3.6 V). |
| $48,53,61,67,74,82$ | DRGND 1 | Digital Output Ground. |
| 49 | DB3 | B Port Output Data Bit. |
| 50 | DB4 | B Port Output Data Bit. |
| 51 | DB5 | B Port Output Data Bit. |
| 52 | DB6 | B Port Output Data Bit. |
| 55 | DB7 | B Port Output Data Bit. |
| 56 | DB8 | B Port Output Data Bit. |
| 57 | DB9 | B Port Output Data Bit. |
| 58 | DB10 | B Port Output Data Bit. |
| 59 | DB11 | B Port Output Data Bit (MSB). |
| 60 | OR_B | B Port Overrange. |
| 63 | DCO- | Data Clock Output-Complement. |
| 64 | DCO+ | Data Clock Output-True. |
| 69 | DA0 | A Port Output Data Bit (LSB). |
| 70 | DA1 | A Port Output Data Bit. |
| 71 | DA2 | A Port Output Data Bit. |
| 72 | DA3 | A Port Output Data Bit. |
| 73 | DA4 | A Port Output Data Bit. |
| 76 | DA5 | A Port Output Data Bit. |
| 77 | DA6 | A Port Output Data Bit. |
| 78 |  | A Port Output Data Bit. |
| 79 | DA7 | A Port Output Data Bit. |
| 80 | DA8 | A Port Output Data Bit. |
| 81 | DA9 | A Port Output Data Bit. |
| 84 | DA10 | A Port Output Data Bit (MSB). |

[^1]

Table 8. LVDS Mode Pin Function Descriptions

| Pin Number | Mnemonic | Description |
| :---: | :---: | :---: |
| 1 | S5 | Full-Scale Adjust Pin. AVDD sets $\mathrm{f}_{\mathrm{s}}=0.768 \mathrm{~V} p-\mathrm{p}$ differential, GND sets $\mathrm{f}_{\mathrm{s}}=1.536 \mathrm{~V}$ p-p differential. |
| 2,42 to 46 | DNC | Do Not Connect. |
| 3 | S4 | Control Pin for CMOS Mode. Tie low when operating in LVDS mode. |
| $\begin{aligned} & 4,9,12,13,16,17,20,23,25,26,30,31,35,38,41,86,87,91 \text {, } \\ & 92,93,96,97,100 \end{aligned}$ | AGND ${ }^{1}$ | Analog Ground. |
| 5 | S2 | Output Mode Select. GND = dual-port CMOS; AVDD = LVDS. |
| 6 | S1 | Data Format Select. GND = binary, AVDD = twos complement. |
| 7 | LVDSBIAS | Set Pin for LVDS Output Current. Place 3.74 kW resistor terminated to ground. |
| $\begin{aligned} & 8,14,15,18,19,24,27,28,29,33,34,39,40,88,89,90,94,95, \\ & 98,99 \end{aligned}$ | AVDD ${ }^{2}$ | 3.3 V Analog Supply. |
| 10 | SENSE | Reference Mode Select Pin. Float for internal reference operation. |
| 11 | VREF | 1.235 V Reference I/O—Function Dependent on SENSE. |
| 21 | VIN+ | Analog Input-True. |
| 22 | VIN- | Analog Input-Complement. |
| 32 | GND | Data Sync (Input)—Not Used in LVDS Mode. Tie to GND. |
| 36 | CLK+ | Clock Input-True (LVPECL Levels). |
| 37 | CLK- | Clock Input-Complement (LVPECL Levels). |

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| Pin Number | Mnemonic | Description |
| :--- | :--- | :--- |
| $47,54,62,75,83$ | DRVDD | 3.3 V Digital Output Supply (3.0 V to 3.6 V). |
| $48,53,61,67,74,82$ | DRGND ${ }^{1}$ | Digital Output Ground. |
| 49 | D0- | D0 Complement Output Bit (LSB). |
| 50 | D0+ | D0 True Output Bit (LSB). |
| 51 | D1- | D1 Complement Output Bit. |
| 52 | D1+ | D1 True Output Bit. |
| 55 | D2- | D2 Complement Output Bit. |
| 56 | D2+ | D2 True Output Bit. |
| 57 | D3- | D3 Complement Output Bit. |
| 58 | D3+ | D3 True Output Bit. |
| 59 | D4- | D4 Complement Output Bit. |
| 60 | D4+ | D4 True Output Bit. |
| 63 | DCO- | Data Clock Output-Complement. |
| 64 | DCO+ | Data Clock Output-True. |
| 65 | D5- | D5 Complement Output Bit. |
| 66 | D5+ | D5 True Output Bit. |
| 68 | D6- | D6 Complement Output Bit. |
| 69 | D6+ | D6 True Output Bit. |
| 70 | D7- | D7 Complement Output Bit. |
| 71 | D7+ | D7 True Output Bit. |
| 72 | D8- | D8 Complement Output Bit. |
| 73 | D8+ | D8 True Output Bit. |
| 76 | D9- | D9 Complement Output Bit. |
| 77 |  | D9 True Output Bit. |
| 78 |  | D10 Complement Output Bit. |
| 79 |  | D10- |
| 81 |  | D10 True Output Bit. |
| 84 | D11- | D11 Complement Output Bit. |
| 85 | D11+ | D11 True Output Bit. |

[^2]
## EQUIVALENT CIRCUITS



Figure 6. ENCODE and DS Input


Figure 7. Analog Inputs



Figure 9. VREF, SENSE I/O


Figure 10. Data Outputs (CMOS Mode)


Figure 11. Data Outputs (LVDS Mode)

## AD9430

## TYPICAL PERFORMANCE CHARACTERISTICS

Charts at 170 MSPS, 210 MSPS for $-170,-210$ grades, respectively. AVDD, $\operatorname{DRVDD}=3.3 \mathrm{~V}, \mathrm{~T}=25^{\circ} \mathrm{C}, \mathrm{A}_{\text {IN }}$ differential drive, full scale $=1.536 \mathrm{~V}$, internal reference unless otherwise noted.


Figure 12. $\mathrm{FFT}: \mathrm{f}_{\mathrm{s}}=170 \mathrm{MSPS}, A_{I N}=10.3 \mathrm{MHz} @-0.5 \mathrm{dBFS}$, LVDS Mode


Figure 13. FFT: $f_{s}=170 \mathrm{MSPS}, A_{I N}=65 \mathrm{MHz} @-0.5 \mathrm{dBFS}$, LVDS Mode


Figure 14. FFT: $f_{s}=170 \mathrm{MSPS}, A_{i N}=65 \mathrm{MHz} @-0.5 \mathrm{dBFS}, \mathrm{CMOS}$ Mode


Figure 15. FFT: $f_{s}=170 \mathrm{MSPS}, A_{i N}=10.3 \mathrm{MHz} @-0.5 \mathrm{dBFS}$, Single-Ended Input, Full Scale $=0.76$ V, LVDS Mode


Figure 16. FFT: $f_{s}=210 \mathrm{MSPS}, A_{I N}=10.3 \mathrm{MHZ} @-0.5 \mathrm{dBFS}$, LVDS Mode


Figure 17. FFT: $f_{s}=210 \mathrm{MSPS}, A_{I N}=65 \mathrm{MHz} @-0.5 \mathrm{dBFS}, \mathrm{CMOS}$ Mode


Figure 18. FFT: $f_{s}=210 \mathrm{MSPS}, A_{I N}=65 \mathrm{MHz} @-0.5 \mathrm{dBFS}$, LVDS Mode


Figure 19. SNR, SINAD, and SFDR vs. Ain Frequency, $f_{s}=210$ MSPS,
Ain @ -0.5 dBFS, LVDS Mode


Figure 20. Harmonic Distortion ( $2^{\text {nd }}$ and $3^{\text {rd }}$ )
and SFDR vs. AIN Frequency


Figure 21. FFT: $f_{s}=213 \mathrm{MSP}, A_{I N}=100 \mathrm{MHz} @-0.5 \mathrm{dBFS}$, LVDS Mode


Figure 22. SNR and SINAD vs. AIN Frequency, $f_{s}=210$ MSPS,
$A_{\text {IN }} @-0.5$ dBFS, LVDS Mode, Full Scale $=0.76 \mathrm{~V}$


Figure 23. Harmonic Distortion ( $2^{\text {nd }}$ and $3^{\text {rd }}$ ) and SFDR vs. Ais Frequency, $f_{s}=170$ MSPS, CMOS Mode

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Figure 24. SNR and SINAD vs. AiN Frequency, $f_{s}=170 \mathrm{MSPS} / 210 \mathrm{MSPS}$, AIN @ -0.5dBFS, LVDS Mode


Figure 25. SNR and SINAD, SFDR vs. AIN Frequency, $f_{s}=210 \mathrm{MSPS}, A_{\mathrm{IN}} @-0.5 \mathrm{dBFS}$, CMOS Mode


Figure 26. Two-Tone Intermodulation Distortion (28.3 MHz and 29.3 MHz, LVDS Mode, $f_{s}=170 \mathrm{MSPS}$ )


Figure 27. Two-Tone Intermodulation Distortion ( 59 MHz and 60 MHz ), LVDS Mode, $f_{s}=210 \mathrm{MSPS}$


Figure 28. SINAD and SFDR vs. Clock Rate ( $A_{I N}=10.3 \mathrm{MHz} @-0.5 \mathrm{dBFS}$, LVDS Mode), -170 Grade


Figure 29. SNR and SINAD, SFDR vs. Clock Rate ( $A_{I N}=10.3 \mathrm{MHz}$, @-0.5 dBFS), LVDS Mode, -210 Grade


Figure 30. $I_{A V D D}$ and $I_{D R V D D}$ vs. Clock Rate $\left(A_{I N}=10.3 \mathrm{MHz} @-0.5 \mathrm{dBFS}\right)$
170 MSPS Grade, C LOAD $=5 \mathrm{pF}$


Figure 31. I IVDD and IDRVDD vs. Clock Rate
$\left(A_{I N}=10.3 \mathrm{MHz} @-0.5 \mathrm{dBFS}\right), 210 \mathrm{MSPS}$ Grade, $C_{\text {LOAD }}=5 \mathrm{pF}$


Figure 32. SINAD and SFDR vs. Clock Pulse Width High
( $A_{I N}=10.3 \mathrm{MHz} @-0.5 \mathrm{dBFS}, 170 \mathrm{MSPS}$, LVDS)


Figure 33. SNR, SINAD, and SFDR vs. ENCODE Pulse Width High, ( $A_{I N}=10.3 \mathrm{MHz} @-0.5 \mathrm{dBFS}, 210 \mathrm{MSPS}$, LVDS)


Figure 34. VREFOut Vs. I LoAd


Figure 35. Full-Scale Gain Error vs. Temperature ( $A_{\text {IN }}=10.3 \mathrm{MHz} @-0.5 \mathrm{dBFS}, 170 \mathrm{MSPS} / 210 \mathrm{MSPS}$, LVDS $)$

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Figure 36. VREF Output Voltage vs. AVDD


Figure 37. SNR, SINAD, and SFDR vs. Temperature
( $A_{I_{N}}=10.3 \mathrm{MHz} @-0.5 \mathrm{dBFS}, 170 \mathrm{MSPS}$ )


Figure 38. SINAD vs. Temperature, AVDD
( $A_{\text {IN }}=70 \mathrm{MHz} @-0.5 \mathrm{~dB}, 210 \mathrm{MSPS}$, LVDS Mode)


Figure 39. Typical INL Plot ( $A_{I N}=10.3 \mathrm{MHz} @-0.5 \mathrm{dBFS}, 170 \mathrm{MSPS}$, LVDS)


Figure 40. Typical DNL Plot ( $A_{I N}=10.3 \mathrm{MHz} @-0.5 \mathrm{dBFS}$ )


Figure 41. SFDR vs. AIN Input Level,
AIN @ $10.3 \mathrm{MHz}, 170$ MSPS, LVDS Mode


Figure 42. SFDR vs. $A_{\text {IN }}$ Input Level, $A_{I N} @ 10.3 \mathrm{MHz}, 210 \mathrm{MSPS}$, LVDS/CMOS Modes


Figure 43. SFDR vs. Ais Input Level, $A_{i N} @ 10.3 \mathrm{MHz}, 210 \mathrm{MSPS}$, LVDS Mode,
Full Scale $=0.76 \mathrm{~V} / 1.536 \mathrm{~V}$


Figure 44. Noise Power Ratio Plot


Figure 45. W-CDMA Four Channels Centered at 38.4 MHz , $f_{s}=153.6 \mathrm{MHz}$, LVDS Mode


Figure 46. SNR, SINAD, and SFDR vs. Full-Scale Range, $S 5=0$, Full-Scale Range Varied by Adjusting VREF, 170 MSPS


Figure 47. Propagation Delay vs. Temperature, LVDS Mode, 170 MSPS/210 MSPS

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Figure 48. Propagation Delay vs. Temperature, CMOS Mode, 170 MSPS/210 MSPS


Figure 49. LVDS Output Swing, Common-Mode Voltage vs. RSET, Placed at LVDSBIAS, 170 MSPS/210 MSPS

## TERMINOLOGY

## Analog Bandwidth

The analog input frequency at which the spectral power of the fundamental frequency (as determined by the FFT analysis) is reduced by 3 dB .

## Aperture Delay

The delay between the $50 \%$ point of the rising edge of the ENCODE command and the instant at which the analog input is sampled.

## Aperture Uncertainty (Jitter)

The sample-to-sample variation in aperture delay.

## Crosstalk

Coupling onto one channel being driven by a low level ( -40 dBFS ) signal when the adjacent interfering channel is driven by a full-scale signal.

Differential Analog Input Resistance, Differential Analog Input Capacitance, and Differential Analog Input Impedance The real and complex impedances measured at each analog input port. The resistance is measured statically and the capacitance and differential input impedances are measured with a network analyzer.

## Differential Analog Input Voltage Range

The peak-to-peak differential voltage that must be applied to the converter to generate a full-scale response. Peak differential voltage is computed by observing the voltage on a single pin and subtracting the voltage from the other pin, which is $180^{\circ}$ out of phase. Peak-to-peak differential is computed by rotating the input phase $180^{\circ}$ and again taking the peak measurement. The difference is then computed between both peak measurements.

## Differential Nonlinearity

The deviation of any code width from an ideal 1 LSB step.

## Effective Number of Bits (ENOB)

Calculated from the measured SNR based on the equation

$$
E N O B=\frac{S N R_{\text {MEASURED }}-1.76 \mathrm{~dB}}{6.02}
$$

## ENCODE Pulse Width/Duty Cycle

Pulse width high is the minimum amount of time the ENCODE pulse (clock pulse) should be left in a Logic 1 state to achieve rated performance; pulse width low is the minimum time the ENCODE pulse should be left in a low state. See the timing implications of changing $t_{E H}$ in the Encode Input section. At a given clock rate, these specifications define an acceptable ENCODE duty cycle.

## Full-Scale Input Power

Expressed in dBm . Computed using the following equation:

$$
\text { Power }_{\text {FULL SCALE }}=10 \log \left(\frac{V_{\text {FULL SCALE rms }}^{2}}{\frac{Z_{\text {INPUT }}}{0.001}}\right)
$$

## Gain Error

The difference between the measured and ideal full-scale input voltage range of the ADC.

## Harmonic Distortion, Second

The ratio of the rms signal amplitude to the rms value of the second harmonic component, reported in dBc .

## Harmonic Distortion, Third

The ratio of the rms signal amplitude to the rms value of the third harmonic component, reported in dBc .

## Integral Nonlinearity

The deviation of the transfer function from a reference line measured in fractions of 1 LSB using a best straight line determined by a least square curve fit.

## Minimum Conversion Rate

The ENCODE rate at which the SNR of the lowest analog signal frequency drops by no more than 3 dB below the guaranteed limit.

## Maximum Conversion Rate

The ENCODE rate at which parametric testing is performed.

## Output Propagation Delay

The delay between a differential crossing of CLK+ and CLK- and the time when all output data bits are within valid logic levels.

## Noise (for Any Range Within the ADC)

Calculated as follows:

$$
V_{\text {NOISE }}=\sqrt{Z \times 0.001 \times 10\left(\frac{F S_{d B M}-S N R_{d B c}-\text { Signal }_{d B F S}}{10}\right)}
$$

where:
$Z$ is the input impedance.
$F S$ is the full scale of the device for the frequency in question. $S N R$ is the value of the particular input level.
Signal is the signal level within the ADC, reported in dB below full scale. This value includes input levels both thermal and quantization noise.

## Power Supply Rejection Ratio

The ratio of a change in input offset voltage to a change in power supply voltage.

## Signal-to-Noise and Distortion (SINAD)

The ratio of the rms signal amplitude (set 1 dB below full scale) to the rms value of the sum of all other spectral components, including harmonics but excluding dc.

## Signal-to-Noise Ratio (Without Harmonics)

The ratio of the rms signal amplitude (set at 1 dB below full scale) to the rms value of the sum of all other spectral components, excluding the first five harmonics and dc.

## Spurious-Free Dynamic Range (SFDR)

The ratio of the rms signal amplitude to the rms value of the peak spurious spectral component. The peak spurious component may or may not be a harmonic. Reported in dBc (degrades as signal level is lowered) or dBFS (always related back to converter full scale).

## Two-Tone Intermodulation Distortion Rejection

The ratio of the rms value of either input tone to the rms value of the worst third-order intermodulation product; reported in dBc .

## Two-Tone SFDR

The ratio of the rms value of either input tone to the rms value of the peak spurious component. The peak spurious component may or may not be an IMD product. Reported in dBc (degrades as signal level is lowered) or in dBFS (always related back to converter full scale).

## Worst Other Spur

The ratio of the rms signal amplitude to the rms value of the worst spurious component (excluding the second and third harmonic) reported in dBc .

## Transient Response Time

The time it takes for the ADC to reacquire the analog input after a transient from $10 \%$ above negative full scale to $10 \%$ below positive full scale.

Out-of-Range Recovery Time
The time it takes for the ADC to reacquire the analog input after a transient from $10 \%$ above positive full scale to $10 \%$ above negative full scale, or from $10 \%$ below negative full scale to $10 \%$ below positive full scale.

## APPLICATION NOTES

## THEORY OF OPERATION

The AD9430 architecture is optimized for high speed and ease of use. The analog inputs drive an integrated high bandwidth track-and-hold circuit that samples the signal prior to quantization by the 12 -bit core. For ease of use, the part includes an on-board reference and input logic that accepts TTL, CMOS, or LVPECL levels. The digital output logic levels are user selectable as standard 3 V CMOS or LVDS (ANSI-644 compatible) via Pin S2.

## ENCODE INPUT

Any high speed ADC is extremely sensitive to the quality of the sampling clock provided by the user. A track-and-hold circuit is essentially a mixer, and any noise, distortion, or timing jitter on the clock is combined with the desired signal at the A/D output. For that reason, considerable care has been taken in the design of the clock inputs of the AD9430, and the user is advised to give careful thought to the clock source.

The AD9430 has an internal clock duty cycle stabilization circuit that locks to the rising edge of CLK+ and optimizes timing internally. This allows for a wide range of input duty cycles at the input without degrading performance. Jitter in the rising edge of the input is still of paramount concern and is not reduced by the internal stabilization circuit. The duty cycle control loop does not function for clock rates less than 30 MHz nominally. The loop has a time constant associated
with it that needs to be considered in applications where the clock rate can change dynamically, requiring a wait time of $1.5 \mu$ s to $5 \mu$ s after a dynamic clock frequency increase before valid data is available. This circuit is always on and cannot be disabled by the user.

The clock inputs are internally biased to 1.5 V (nominal) and support either differential or single-ended signals. For best dynamic performance, a differential signal is recommended. An MC100LVEL16 performs well in the circuit to drive the clock inputs, as illustrated in Figure 50. (For trace lengths $>2$ inches, a standard LVPECL termination is recommended rather than the simple pull-down as shown.) Note that for this low voltage PECL device, the ac coupling is optional.


Figure 50. Driving Clock Inputs with LVEL16
In interleaved mode, output data on Port A is offset from output data changes on Port B by one-half output clock cycle, as shown in Figure 51.


Figure 51.

Table 9. Output Select Coding

| $\text { S1 }{ }^{1}$ <br> (Data Format Select) | $\begin{aligned} & \text { S2 }{ }^{1} \\ & \text { (LVDS/CMOS Mode Select) }^{2} \end{aligned}$ | $\begin{aligned} & \text { S4 }{ }^{1} \\ & \text { (I/P Select) } \end{aligned}$ | $\begin{aligned} & \text { S5 }{ }^{1} \\ & \text { (Full-Scale Select) }{ }^{3} \end{aligned}$ | Mode |
| :---: | :---: | :---: | :---: | :---: |
| 1 | X | X | X | Twos complement |
| 0 | X | X | X | Offset binary |
| X | 0 | 1 | X | Dual-mode CMOS interleaved |
| X | 0 | 0 | X | Dual-mode CMOS parallel |
| X | 1 | X | X | LVDS mode |
| X | X | X | 1 | Full scale $=0.768 \mathrm{~V}$ |
| X | X | X | 0 | Full scale $=1.536 \mathrm{~V}$ |

[^3]
## ANALOG INPUT

The analog input to the AD9430 is a differential buffer. For best dynamic performance, impedances at VIN+ and VINshould match. The analog input is optimized to provide superior wideband performance and requires that the analog inputs be driven differentially. SNR and SINAD performance degrades significantly if the analog input is driven with a singleended signal.

A wideband transformer such as the Mini-Circuit ${ }^{\circ}$ ADT1-1WT can provide the differential analog inputs for applications that require a single-ended-to-differential conversion. Both analog inputs are self-biased by an on-chip resistor divider to a nominal 2.8 V. (See the Equivalent Circuits section.)

Special care was taken in the design of the analog input section of the AD9430 to prevent damage and corruption of data when the input is overdriven. The nominal differential input range is approximately 1.5 V p-p $\sim(768 \mathrm{mV} \times 2)$. Note that the best SNR performance is achieved with $\mathrm{S} 5=0$ (full scale $=1.5$ ).


Figure 52. Differential Analog Input Range


## DS INPUTS (DS+, DS-)

In CMOS output mode, the data sync inputs (DS+, DS-) can be used in applications that require a given sample to appear at a specific output port (A or B) relative to a given external timing signal. The DS inputs can also be used to synchronize two or more ADCs in a system to maintain phasing between Port A and Port B on separate ADCs (in effect, synchronizing multiple DCO outputs). When DS+ is held high (DS- low), the ADC data outputs and clock do not switch and are held static. Synchronization is accomplished by the assertion (falling edge) of DS+ within the timing constraints $\mathrm{t}_{\text {SDS }}$ and $\mathrm{t}_{\mathrm{HDS}}$, relative to a clock rising edge. (On initial synchronization, $\mathrm{t}_{\mathrm{HDS}}$ is not relevant.) If DS+ falls within the required setup time ( $\mathrm{t}_{\text {sDs }}$ ) before a given clock rising edge, N , the analog value at that point in time is digitized and available at Port A, 14 cycles later in interleaved mode.

The very next sample, $\mathrm{N}+1$, is sampled by the next rising clock edge and available at Port B, 14 cycles after that clock edge. In dual-parallel mode, Port A has a 15-cycle latency and Port B has a 14 -cycle latency, but data is available at the same time. Driving the DS inputs of each ADC by the same sync signal accomplishes this. An easy way to accomplish synchronization is by a one-time sync at power-on reset. Note that when running the AD9430 in LVDS mode, set DS + to ground and DS- to 3.3 V , as the DS inputs are relevant only in CMOS output mode, simplifying the design for some applications as well as affording superior SNR/SINAD performance at higher encode/analog frequencies.

## CMOS OUTPUTS

The off-chip drivers on the chip can be configured to provide CMOS-compatible output levels via Pin S2. The CMOS digital outputs ( $\mathrm{S} 2=0$ ) are TTL/CMOS compatible for lower power consumption. The outputs are biased from a separate supply (DRVDD), allowing easy interface to external logic. The outputs are CMOS devices that swing from ground to DRVDD (with no dc load). It is recommended to minimize the capacitive load the ADC drives by keeping the output traces short ( $<1$ inch, for a total $\mathrm{C}_{\text {LOAD }}<5 \mathrm{pF}$ ). When operating in CMOS mode, it is also recommended to place low value ( $20 \Omega$ ) series damping resistors on the data lines to reduce switching transient effects on performance.

## LVDS OUTPUTS

The off-chip drivers on the chip can be configured to provide LVDS-compatible output levels via Pin S2. LVDS outputs are available when $\mathrm{S} 2=\mathrm{VDD}$ and a $3.74 \mathrm{k} \Omega$ RSET resistor is placed at Pin 7 (LVDSBIAS) to ground. The RSET resistor current is ratioed on-chip, setting the output current at each output equal to a nominal $3.5 \mathrm{~mA}(11 \times$ IRSET $)$. A $100 \Omega$ differential termination resistor placed at the LVDS receiver inputs results in a nominal 350 mV swing at the receiver. LVDS mode facilitates interfacing with LVDS receivers in custom ASICs and FPGAs that have LVDS capability for superior switching performance in noisy environments. Single point-to-point net topologies are recommended with a $100 \Omega$ termination resistor as close to the receiver as possible. It is recommended to keep the trace length three to four inches maximum and to keep differential output trace lengths as equal as possible.

## CLOCK OUTPUTS (DCO+, DCO-)

The input ENCODE is divided by two (in CMOS mode) and available off chip at DCO+ and DCO-. These clocks can facilitate latching off chip, providing a low skew clocking solution (see Figure 2). The on-chip clock buffers should not drive more than 5 pF of capacitance to limit switching transient effects on performance. Note that the output clocks are CMOS levels when CMOS mode is selected $(\mathrm{S} 2=0)$ and are LVDS levels when in LVDS mode ( $\mathrm{S} 2=\mathrm{V}_{\mathrm{DD}}$ ), requiring a $100 \Omega$ differential termination at receiver in LVDS mode. The output clock in LVDS mode switches at the ENCODE rate.

## VOLTAGE REFERENCE

A stable and accurate 1.23 V voltage reference is built into the AD9430 (VREF). The analog input full-scale range is linearly proportional to the voltage at VREF. Note that an external reference can be used by connecting the SENSE pin to VDD (disabling internal reference) and driving VREF with the external reference source. No appreciable degradation in performance occurs when VREF is adjusted $\pm 5 \%$. A $0.1 \mu \mathrm{~F}$ capacitor to ground is recommended at the VREF pin in internal and external reference applications. Float the SENSE pin for internal reference operation.


Figure 54. Using an External Reference

## NOISE POWER RATIO TESTING (NPR)

NPR is a test that is commonly used to characterize the return path of cable systems where the signals are typically QAM signals with a noise-like frequency spectrum. NPR performance of the AD9430 was characterized in the lab yielding an effective $\mathrm{NPR}=56.9 \mathrm{~dB}$ at an analog input of 19 MHz . This agrees with a theoretical maximum NPR of 57.1 dB for an 11-bit ADC at 13.6 dB backoff. The rms noise power of the signal inside the notch is compared with the rms noise level outside the notch using an FFT. Sufficiently long record lengths to guarantee a sufficient number of samples inside the notch are a requirement, as well as a high order band-stop filter that provides the required notch depth for testing.

## EVALUATION BOARD, CMOS MODE

The AD9430 evaluation board offers an easy way to test the AD9430 in CMOS mode. It requires a clock source, an analog input signal, and a 3.3 V power supply. The clock source is buffered on the board to provide the clocks for the ADC, latches, and data ready signals. The digital outputs and output clocks are available at two $40-$ pin connectors, P3 and P23. The PCB interfaces directly with ADI standard dual-channel data capture board (HSC-ADC-EVAL-DC) which, together with ADI ADC Analyzer software, allows for quick ADC evaluation. The board has several different modes of operation and is shipped in the following configurations:

- Offset binary
- Internal voltage reference
- CMOS parallel timing
- Full-scale adjust = low


## POWER CONNECTOR

Power is supplied to the board via a detachable 12-lead power strip (three 4-pin blocks). AVDD, DRVDD, and VDL are the minimum required power connections.

Table 10. Power Connector, CMOS Mode

| AVDD 3.3 V | Analog supply for ADC $(350 \mathrm{~mA})$ |
| :--- | :--- |
| DRVDD 3.3 V | Output supply for ADC (28 mA) |
| VDL 3.3 V | Supply for support logic and DAC (350 mA) |
| EXT_VREF | Optional external reference input |
| VCLK/V_XTAL | Supply for clock buffer/optional CRYSTAL |
| VAMP | Supply for optional amp |

## ANALOG INPUTS

The evaluation board accepts a 1.3 V p-p analog input signal centered at ground at SMB connector J4. This signal is terminated to ground through $50 \Omega$ by R16. The input can be alternatively terminated at the transformer T1 secondary by R13 and R14. T1 is a wideband RF transformer providing the single-ended-to-differential conversion, allowing the ADC to be driven differentially and minimizing even-order harmonics. An optional second transformer, T2, can be placed following T1 if desired. This provides some performance advantage ( $\sim 1 \mathrm{~dB}$ to 2 dB ) for high analog input frequencies ( $>100 \mathrm{MHz}$ ). If T2 is placed, two shorting traces at the pads need to be cut. The analog signal is low-pass filtered by R41, C12 and R42, and C 13 at the ADC input.

## GAIN

Full scale is set at E17, E18, and E19. Connecting E17 to E18 sets S5 low, full scale $=1.5 \mathrm{~V}$ differential; connecting E17 to E19 sets S 5 high, full scale $=0.75 \mathrm{~V}$ differential.

## ENCODE

The ENCODE clock is terminated to ground through $50 \Omega$ at SMB Connector J5. The input is ac coupled to a high speed differential receiver (LVEL16) that provides the required low jitter, fast edge rates needed for optimum performance. J5 input should be $>0.5 \mathrm{~V}$ p-p. Power to the EL16 is set at Jumper E47. Connecting E47 to E45 powers the buffer from AVDD; connecting E47 to E46 powers the buffer from VCLK/V_XTAL.

## VOLTAGE REFERENCE

The AD9430 has an internal 1.23 V voltage reference. The ADC uses the internal reference as the default when jumpers E24 to E27 and E25 to E26 are left open. The full scale can be increased by placing optional Resistor R3. The required value varies with the process and needs to be tuned for the specific application. Full scale can similarly be reduced by placing R4; tuning is required here as well. An external reference can be used by shorting the SENSE pin to 3.3 V (place Jumper E26 to E25). The E27 to E24 jumper connects the ADC VREF pin to the EXT_VREF pin at the power connector.

## DATA FORMAT SELECT

Data format select sets the output data format of the ADC. Setting DFS (E1 to E2) low sets the output format to be offset binary; setting DFS high (E1 to E3) sets the output to twos complement.

## I/P TIMING SELECT

Output timing is set at E11, E12 and E13. E12 to E11 sets S4 low for parallel output timing mode. E11 to E13 sets S4 high for interleaved timing mode.

## TIMING CONTROLS

Flexibility in latch clocking and output timing is accomplished by allowing for clock inversion at the timing controls section of the PCB. Each buffered clock is buffered by an XOR and can be inverted by moving the appropriate jumper for that clock.

## CMOS DATA OUTPUTS

The ADC CMOS digital outputs are latched on the board by four LVT574s; the latch outputs are available at the two 40-pin connectors at Pin 11 through Pin 33 on P23 (Channel A) and Pin 11 through Pin 33 on P3 (Channel B). The latch output clocks (data ready) are available at Pin 37 on P23 (Channel A) and Pin 37 on P3 (Channel B). The data-ready clocks can be inverted at the timing controls section if needed.


## CRYSTAL OSCILLATOR

An optional crystal oscillator can be placed on the board to serve as a clock source for the PCB. Power to the oscillator is through the VCLK pin at the power connector (also called VCLK/V_XTAL). If an oscillator is used, ensure proper termination for best results. The board has been tested with a Valpey Fisher VF561 and a Vectron JN00158-163.84. Test results for the VF561 are shown in Figure 56.


Figure 56. FFT—Using VF561 Crystal as Clock Source

## OPTIONAL AMPLIFIER

The evaluation board as shipped uses a wideband RF transformer in its analog path. A user can modify the board to use the AD8351 op amp for ac- or dc-coupled applications (see Figure 59 and Figure 60). Figure 60 shows the AD8351 in an ac-coupled topology, while Figure 57 shows the AD8351 in a dc-coupled application. Optimum performance is obtained with the AD8351 ac coupled.


Figure 57. Using the AD8351 on the AD9430 PCB

## AD9430

## TROUBLESHOOTING

If the board does not seem to be working correctly, try the following:

- Verify power at IC pins.
- Check that all jumpers are in the correct position for the desired mode of operation.
- Verify that VREF is at 1.23 V .
- Run the clock and analog inputs at low speeds (10 MSPS/ 1 MHz ) and monitor latch and ADC for toggling.

The AD9430 evaluation board is provided as a design example for customers of Analog Devices, Inc. ADI makes no warranties, express, statutory, or implied, regarding merchantability or fitness for a particular purpose.


Table 11. CMOS PCB Evaluation Board Bill of Material

| No. | Quantity | Reference Designator | Device | Package | Value | Comments |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 1 | 47 | $\begin{aligned} & \hline \text { C1, C3-C11, C15-C44, } \\ & \text { C47, C48, C58-C62 } \end{aligned}$ | Capacitor | 0402 | $0.1 \mu \mathrm{~F}$ | $\begin{aligned} & \text { C11, C18, C30, C33, } \\ & \text { C34, C39, C40, C48 } \\ & \text { Not placed } \end{aligned}$ |
| 2 | 1 | C2 | Capacitor | 0402 | 10 pF | Not placed |
| 3 | 1 | C12 | Capacitor | 0402 | 20 pF | Not placed |
| 4 | 29 | $\begin{aligned} & \text { C13, C14, C45, C46, C50-C57, } \\ & \text { C68-C84 } \end{aligned}$ | Capacitor | 0402 | $0.01 \mu \mathrm{~F}$ | All .01uF caps not placed |
| 5 | 6 | C49, C63-C67 | Capacitor | CAPL | $10 \mu \mathrm{~F}$ |  |
| 6 | 8 | $\begin{aligned} & \text { (E3, E1, E2),( E19, E17, E18), } \\ & \text { (E13, E11, E12),( E46, E47, E45), } \\ & \text { (E35, E33, E34),( E32, E30, E31), } \\ & \text { (E29, E23, E28),( E22, E16, E21) } \end{aligned}$ | 3-pin header/jumper |  |  |  |
| 7 | 1 | E26, E25, E27, E24 | 4-pin header/jumper |  |  |  |
| 8 | 4 | J1, J2, J4, J5 | SMA | SMA |  | J2 not placed |
| 9 | 2 | P3, P23 ${ }^{1}$ | Connector |  |  |  |
| 10 | 3 | P4, P21, P22 | 4-pin power connector | Post | Z5.531.3425.0 | Wieland |
| 11 | 3 | P4, P21, P22 | 4-pin power connector | Detachable connector | 25.602.5453.0 | Wieland |
| 12 | 4 | R1, R5, R16, R27 | Resistor | 0402 | $50 \Omega$ | R1 not placed |
| 13 | 3 | R2, R3, R4 | Resistor | 0402 | $3.8 \mathrm{~K} \Omega$ | R3, R4 not placed |
| 14 | 8 | R6-R8, R10, R33-R36 | Resistor | 0603 | $100 \Omega$ | R34 not placed |
| 15 | 2 | R9, R11 | Resistor | 0402 | $0 \Omega$ |  |
| 16 | 17 | $\begin{aligned} & \text { R12, R15, R21-R26, R28-R31, R37, } \\ & \text { R38, R43, R46, R47 } \end{aligned}$ | Resistor | 0402 | User selected | All 17 not placed |
| 17 | 6 | R13, R14, R41, R42, R44, R45 | Resistor | 0402 | $25 \Omega$ | R13, R14, R44, R45 not placed |
| 18 | 2 | R17, R18 | Resistor | 0402 | $510 \Omega$ |  |
| 19 | 2 | R19, R20 | Resistor | 0402 | $150 \Omega$ |  |
| 20 | 2 | R39, R40 | Resistor | 0402 | $1 \mathrm{k} \Omega$ |  |
| 21 | 8 | ```RZ1, RZ2, RZ3, RZ4, RZ5, RZ6, RZ7, RZ8``` | Resistor pack $220 \Omega$ | SO16RES | 742C163221JTR | CTS |
| 22 | 1 | L1 | Inductor | 0603 | User selected | Not placed |
| 23 | 2 | T1,T4 | Transformer | CD542 | Mini-Circuits ADT1-1WT | T4 not placed |
| 24 | 2 | T2, 73 | Optional Macom Transformer | SM-22 | ETC1-1-13 | Not placed |
| 25 | 1 | U1 | AD9430BSV (-210) | TQFP100 | ADC |  |
| 26 | 1 | U2 | MC100LVEL16D | SO8NB | Clock buffer |  |
| 27 | 1 | U3 | VCX86 | SO14NB | XOR |  |
| 28 | 4 | U4, U5, U6, U7 | LVT574 | SO20 |  |  |
| 29 | 1 | U8 | JN00158 |  | Optional XTAL | Not placed |
| 30 | 1 | U9 | AD8351 |  | Amp |  |

[^4]
## AD9430



Figure 59. Evaluation Board Schematic—CMOS


Figure 60. Evaluation Board Schematic—CMOS (continued)

## AD9430



Figure 61. PCB Top-Side Silkscreen


Figure 62. PCB Top-Side Copper


Figure 63. PCB Ground Layer


Figure 64. PCB Split Power Plane


Figure 65. PCB Bottom-Side Copper


Figure 66. PCB Bottom-Side Silkscreen

## AD9430

## EVALUATION BOARD, LVDS MODE

The AD9430 evaluation board offers an easy way to test the AD9430 in LVDS mode. (The board is also compatible with the AD9411.) It requires a clock source, an analog input signal, and a 3.3 V power supply. The clock source is buffered on the board to provide the clocks for the ADC, latches, and a data-ready signal. The digital outputs and output clocks are available at a 40 -pin connector, P23. The board has several different modes of operation and is shipped in the following configurations:

- Offset binary
- Internal voltage reference
- Full-scale adjust = low

Note that the AD9430 LVDS evaluation board does not interface directly with the standard Analog Devices dualchannel data capture board (HSC-ADC-EVAL-DC). An LVDS-to-CMOS translation board is required and is available from Analog Devices. (No translation board is required for the AD9430 CMOS evaluation board.)

## POWER CONNECTOR

Power is supplied to the board via a detachable 8-lead power strip (two 4-pin blocks). In Table 12, VCC, DRVDD, and VDL are the minimum required power connections, and the LVEL16 clock buffer can be powered from VCC or VDL at the E47 jumper.
Table 12. Power Connector, LVDS Mode

| VCC 3.3 V | Analog supply for ADC ( 350 mA$)$ |
| :--- | :--- |
| DRVDD 3.3 V | Output supply for ADC $(50 \mathrm{~mA})$ |
| VDL 3.3V | Supply for support logic |
| EXT_VREF | Optional external reference input |

## ANALOG INPUTS

The evaluation board accepts a 1.3 V p-p analog input signal centered at ground at SMB Connector J4. This signal is terminated to ground through $50 \Omega$ by R16. The input can be alternatively terminated at the T1 transformer secondary by R13 and R14. T1 is a wideband RF transformer providing the single-ended-to-differential conversion, allowing the ADC to be driven differentially and minimizing even-order harmonics. An optional second transformer, T2, can be placed following T1 if desired. This provides some performance advantage ( $\sim 1$ to 2 dB ) for high analog input frequencies ( $>100 \mathrm{MHz}$ ). If T2 is placed, two shorting traces at the pads need to be cut. The analog signal can be low-pass filtered by R41, C12 and R42, and C13 at the ADC input. A wideband differential amplifier (AD8351) can be configured on the PCB for dc-coupled applications. Remove C6, C15, and C30 to prevent transformer loading of the amp. See Figure 67, Figure 68, and Figure 69 for more information.

## GAIN

Full scale is set at E17 to E19, E17 to E18 sets S5 low, full scale = 1.5 V differential; E17 to E19 sets S5 high, full scale $=0.75 \mathrm{~V}$ differential. Best performance is obtained at 1.5 V full scale.

## CLOCK

The CLOCK input is terminated to ground through a $50 \Omega$ resistor at SMB connector J5. The input is ac coupled to a high speed differential receiver (LVEL16) that provides the required low jitter, fast edge rates needed for optimum performance. J5 input should be $>0.5 \mathrm{~V}$ p-p. Power to the LVEL16 is set at Jumper E47. E47 to E45 powers the buffer from AVDD; E47 to E46 powers the buffer from VCLK/V_XTAL (not in Table 11).

## VOLTAGE REFERENCE

The AD9430 has an internal 1.23 V voltage reference. The ADC uses the internal reference as the default when jumpers E24 to E27 and E25 to E26 are left open. The full scale can be increased by placing optional resistor R3. The required value varies with the process and needs to be tuned for the specific application. Full scale can similarly be reduced by placing R4; tuning is required here as well. An external reference can be used by shorting the SENSE pin to 3.3 V (place jumper E26 to E25). Jumper E27 to E24 connects the ADC VREF pin to the EXT_VREF pin at the power connector.

## DATA FORMAT SELECT

Data format select (DFS) sets the output data format of the ADC. Setting DFS low (E1 to E2) sets the output format to be offset binary; setting DFS high (E1 to E3) sets the output to twos complement.

## DATA OUTPUTS

The ADC LVDS digital outputs are routed directly to the connector at the card edge. Resistor pads have been placed at the output connector to allow for termination if the connector receiving logic does not have the required differential termination for the data bits and DCO. Each output trace pair should be terminated differentially at the far end of the line with a single $100 \Omega$ resistor.

## CRYSTAL OSCILLATOR

An optional crystal oscillator can be placed on the board to serve as a clock source for the PCB. Power to the oscillator is through the VDL pin at the power connector. If an oscillator is used, ensure proper termination for best results. The board has been tested with a Valpey Fisher VF561 and a Vectron JN00158163.84.

Table 13. LVDS PCB Evaluation Board Bill of Material

| No. | Quantity | Reference Designator | Device | Package | Value | Comment |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 1 | 33 | $\begin{aligned} & \text { C1, C4-C11, C15-C17, C19-C32, } \\ & \text { C35, C36, C58-C62 } \\ & \text { C3, C18, C39, C40 } \end{aligned}$ | Capacitors | 0603 | $0.1 \mu \mathrm{~F}$ | C3, C18, C39, C40 not placed |
| 2 | 4 | C33, C34, C37, C38 | Capacitor | 0402 | $0.1 \mu \mathrm{~F}$ | C33, C34, C37, C38 not placed |
| 3 | 4 | C63-C66 | Capacitor | TAJD CAPL | 10 uF |  |
| 4 | 1 | C2 | Capacitor | 0603 | 10 pF | C2 not placed |
| 5 | 2 | C12, C13 | Capacitor | 0603 | 20 pF | C12, C13 not placed |
| 6 | 2 | J4, J5 | Jacks | SMB |  |  |
| 7 | 2 | P21, P22 | Power connectors | 25.602.5453.0 |  |  |
|  |  |  | Top | Wieland |  |  |
| 8 | 2 | P21, P22 | Power connectors Posts | $\begin{aligned} & \text { Z5.531.3425.0 } \\ & \text { Wieland } \end{aligned}$ |  |  |
| 9 | 1 | P23 | 40-pin right-angle connector | $\begin{aligned} & \text { Digi-Key } \\ & \text { S2131-20-ND } \end{aligned}$ |  |  |
| 10 | 16 | R1, R6-R12, R15, R31-R37 | Resistor | 0402 | $100 \Omega$ | R1, R6-R12, R15, R31-37 <br> Not placed |
| 11 | 1 | R2 | Resistor | 0603 | $3.8 \mathrm{k} \Omega$ |  |
| 12 | 3 | R5, R16, R27 | Resistor | 0603 | $50 \Omega$ |  |
| 13 | 2 | R17, R18 | Resistor | 0603 | $510 \Omega$ |  |
| 14 | 2 | R19, R20 | Resistor | 0603 | $150 \Omega$ |  |
| 15 | 2 | R29, R30 | Resistor | 0603 | $1 \mathrm{k} \Omega$ |  |
| 16 | 2 | R41, R42 | Resistor | 0603 | $25 \Omega$ |  |
| 17 | 2 | R3, R4 | Resistor | 0603 | $3.8 \mathrm{k} \Omega$ |  |
| 18 | 2 | R13, R14 | Resistor | 0603 | $25 \Omega$ | R13, R14 not placed |
| 19 | 6 | R22, R23, R24, R25, R26, R28 | Resistor | 0603 | $100 \Omega$ | R22, R23, R24, R25, R26, R28 not placed |
| 20 | 4 | R39, R40, R45, R47 | Resistor | 0402 | $25 \Omega$ | R39, R40, R45, R47 not placed |
| 21 | 2 | R43, R44 | Resistor | 0402 | $10 \mathrm{k} \Omega$ | R43, R44 not placed |
| 22 | 1 | R46 | Resistor | 0402 | $1.2 \mathrm{k} \Omega$ | R46 not placed |
| 23 | 3 | R38, R48, R49 | Resistor | 0402 | $25 \Omega$ | R38, R48, R49 not placed |
| 24 | 2 | R50, R51 | Resistor | 0402 | $1 \mathrm{k} \Omega$ | R50, R51 not placed |
| 25 | 1 | $\begin{aligned} & \text { T1 } \\ & \text { T2 } \end{aligned}$ | RF transformer | Mini-Circuits ADT1-1WT |  | T2 not placed |
| 26 | 1 | U2 | RF amp | AD8351 |  |  |
| 27 | 1 | U9 | Optional crystal oscillator | $\begin{aligned} & \text { JN00158 or } \\ & \text { VF561 } \end{aligned}$ |  |  |
| 28 | 1 | U1 | AD9430 | TQFP-100 |  |  |
| 29 | 1 | U3 | MC100LVEL16 | SO8NB |  |  |

## AD9430



Figure 67. Evaluation Board Schematic—LVDS


TO USE VF561 CRYSTAL


Figure 68. Evaluation Board Schematic—LVDS (continued)


Figure 69. Evaluation Board Schematic—LVDS (continued)

## AD9430



Figure 70. PCB Top-Side Silkscreen-LVDS


Figure 71. PCB Top-Side Copper—LVDS


Figure 72. PCB Ground Layer—LVDS


Figure 73. PCB Split Power Plane—LVDS


Figure 74. PCB Bottom-Side Copper-LVDS


Figure 75. PCB Bottom-Side Silkscreen—LVDS

## OUTLINE DIMENSIONS



NOTES
COMPLIANT TO JEDEC STANDARDS MS-026-AED-HD

1. CENTER FIGURES ARE TYPICAL UNLESS OTHERWISE NOTED.
2. THE AD9430 HAS A CONDUCTIVE HEAT SLUG TO HELP DISSIPATE HEAT AND ENSURE RELIABLE OPERATION OF THE DEVICE OVER THE FULL INDUSTRIAL TEMPERATURE RANGE. THE SLUG IS EXPOSED ON THE BOTTOM OF THE PACKAGE AND ELECTRICALLY CONNECTED TO CHIP GROUND. IT IS RECOMMENDED THAT NO PCB SIGNAL TRACES OR VIAS BE LOCATED UNDER THE PACKAGE THAT COULD COME IN CONTACT WITH THE CONDUCTIVE SLUG. ATTACHING THE SLUG TO A GROUND PLANE WILL REDUCE THE JUNCTION TEMPERATURE OF THE DEVICE WHICH MAY BE BENEFICIAL IN HIGH TEMPERATURE ENVIRONMENTS.

Figure 76.100-Lead Thin Quad Flat Package, Exposed Pad [TQFP_EP]
(SV-100-1)
Dimensions shown in millimeters
ORDERING GUIDE

| Model | Temperature Range | Package Description | Package Option |
| :--- | :--- | :--- | :--- |
| AD9430BSV-170 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 100 -Lead Thin Quad Flat Package, Exposed Pad (TQFP_EP) | SV-100-1 |
| AD9430BSVZ-170 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 100 -Lead Thin Quad Flat Package, Exposed Pad (TQFP_EP) | SV-100-1 |
| AD9430BSV-210 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 100 -Lead Thin Quad Flat Package, Exposed Pad (TQFP_EP) | SV-100-1 |
| AD9430BSVZ-210 ${ }^{1}$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 100 -Lead Thin Quad Flat Package, Exposed Pad (TQFP_EP) | SV-100-1 |
| AD9430-CMOS/PCB |  | Evaluation Board (CMOS Mode) Shipped with -210 Grade |  |
| AD9430-LVDS/PCB |  | Evaluation Board (LVDS Mode) Shipped with -210 Grade |  |

[^5]NOTES

## AD9430

## NOTES


[^0]:    ${ }^{1}$ All ac specifications tested by differentially driving CLK+ and CLK-.
    ${ }^{2}$ DS inputs used in CMOS mode only.

[^1]:    ${ }^{1}$ AGND and DRGND should be tied together to a common ground plane.
    ${ }^{2}$ DS Complement (DS-); can be tied to AVDD (as recommended) or left floating with no ill effects.

[^2]:    ${ }^{1}$ AGND and DRGND should be tied together to a common ground plane
    ${ }^{2}$ Pin 33 can be tied to AVDD (as recommended) or left floating with no ill effects

[^3]:    ${ }^{1} \mathrm{X}=$ don't care.
    ${ }^{2} \mathrm{~S} 4$ used in CMOS mode only ( $\mathrm{S} 2=0$ ). S1 to S 5 all have $30 \mathrm{k} \Omega$ resistive pull-downs on chip.
    ${ }^{3}$ S5 full-scale adjust (see the Analog Input section).

[^4]:    ${ }^{1}$ P3 and P23 are implemented as one physical 80-pin connector, the SAMTEC TSW-140-08-L-D-RA.

[^5]:    ${ }^{1} \mathrm{Z}=\mathrm{Pb}$-free part.

